CAT3200HU2

Low Noise Regulated Charge Pump DC-DC Converter

Description

The CAT3200HU2 is a switched capacitor boost converter that delivers a low noise, regulated output voltage. The CAT3200HU2 gives a fixed regulated 5 V output when the FB pin is tied to ground, otherwise it provides an adjustable output using external resistors. The constant frequency 2 MHz charge pump allows small 1 μF ceramic capacitors to be used.

Maximum output loads of up to 100 mA can be supported over a wide range of input supply voltages making the device ideal for battery−powered applications.

A shutdown control input allows the device to be placed in power−down mode, reducing the supply current to less than 1 μA.

In the event of short circuit or overload conditions, the device is fully protected by both foldback current limiting and thermal overload detection. In addition, a soft start, slew rate control circuit limits inrush current during power−up.

The CAT3200HU2 is available in the tiny 8−pad UDFN 2 mm x 2 mm package.

Features

- Constant High Frequency (2 MHz) Operation
- 100 mA Output Current
- Regulated Output Voltage (5 V Fixed or Adjustable)
- Low Quiescent Current (1.7 mA Typ.)
- Soft Start, Slew Rate Control
- Reverse Leakage Protection
- Thermal Overload Shutdown Protection
- Low Value External Capacitors (1 μF)
- Foldback Current Overload Protection
- Shutdown Current less than 1 μA
- 8−pad UDFN 2 mm x 2 mm Package
- These Devices are Pb−Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- 3 V to 5 V Boost Conversion
- 2.5 V to 3.3 V Boost Conversion
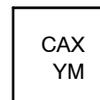- White LED Driver
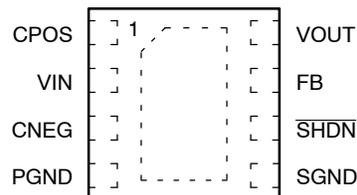- Handheld Portable Devices

ON Semiconductor®

http://onsemi.com

UDFN−8
HU2 SUFFIX
CASE 517AW

MARKING DIAGRAM

CAX
YM

CA = Product Name
X = Assembly Location
Y = Production Year (Last Digit)
M = Production Month (1−9, O, N, D)

PIN CONNECTIONS

CPOS — VOUT
VIN — FB
CNEG — SHDN
PGND — SGND
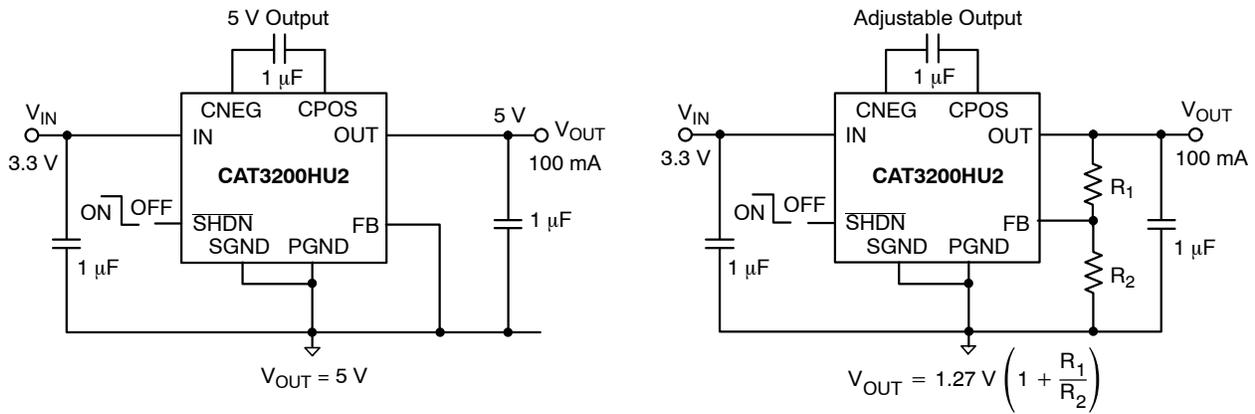
(Top View)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

CAT3200HU2

Figure 1. Typical Application Circuits

Table 1. ORDERING INFORMATION

Orderable Part Number	Output Voltage	Package	Lead Finish	Shipping (Note 1)
CAT3200HU2–GT3	5 V and Adjustable	UDFN–8	NiPdAu	3,000

1. For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Table 2. PIN FUNCTION DESCRIPTION

Pin No.	Pin Name	Description
1	CPOS	Positive connection for the flying capacitor
2	VIN	Input power supply
3	CNEG	Negative connection for the flying capacitor
4	PGND	Power ground
5	SGND	Ground reference for all voltages
6	$\overline{\text{SHDN}}$	Shutdown control logic input (Active LOW)
7	FB	Feedback to set the output voltage
8	VOUT	Regulated output voltage

Table 3. ABSOLUTE MAXIMUM RATINGS

Rating	Value	Unit
V_{IN}, V_{FB}, $\overline{\text{SHDN}}$, C_{NEG}, C_{POS} Voltage	−0.6 to +6	V
V_{OUT}	−0.6 to +7	V
V_{OUT} Short Circuit Duration	Indefinite	
Output Current	200	mA
ESD Protection (HBM)	2000	V
Junction Temperature Range	150	°C
Storage Temperature Range	−65 to +160	°C
Lead Soldering Temperature (10 sec)	300	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 4. RECOMMENDED OPERATING CONDITIONS

Rating	Value	Unit
V_{IN} for 5 V output	2.7 to 4.5	V
V_{IN} for 3.3 V adjustable output	2.2 to 3.0	V
C_{IN}, C_{OUT}, C_{FLY}	1	μF
I_{LOAD}	0 to 100	mA
Ambient Temperature Range	−40 to +85	°C

Table 5. ELECTRICAL CHARACTERISTICS

(Recommended operating conditions unless otherwise specified. C_{IN}, C_{OUT}, C_{FLY} are 1 μF ceramic capacitors and V_{IN} is set to 3.6 V.)

| Parameter	Conditions	Symbol	Min	Typ	Max	Units
Regulated Output	$I_{LOAD} \leq$ 40 mA, $V_{IN} \geq$ 2.7 V, V_{FB} = 0 V	V_{OUT}	4.8	5.0	5.2	V
	$I_{LOAD} \leq$ 100 mA, $V_{IN} \geq$ 3.1 V, V_{FB} = 0 V					
Line Regulation	3.1 V $\leq V_{IN} \leq$ 4.5 V, I_{LOAD} = 50 mA, V_{FB} = 0 V	V_{LINE}		6		mV
Load Regulation	I_{LOAD} = 10 mA to 100 mA, V_{IN} = 3.6 V, V_{FB} = 0 V	V_{LOAD}		20		mV
Switching Frequency		F_{OSC}	1.3	2.0	2.6	MHz
Output Ripple Voltage	I_{LOAD} = 100 mA, V_{OUT} = 5 V, C_{OUT} = 1 μF, excluding ESR on C_{OUT} and PCB	V_R	25	30	45	mVp–p
Efficiency	I_{LOAD} = 50 mA, V_{IN} = 3 V, V_{OUT} = 5 V	η	77	81	85	%
Ground Current	I_{LOAD} = 0 mA, $\overline{SHDN}$ = V_{IN}	I_{GND}		1.6	4	mA
Shutdown Input Current	I_{LOAD} = 0 mA, $\overline{SHDN}$ = 0 V	I_{SHDN}			1	μA
FB Voltage	Adjustable output only	V_{FB}	1.22	1.27	1.32	V
FB Input Current		I_{FB}	−50		50	nA
Open−Loop Resistance	I_{LOAD} = 100 mA, V_{IN} = 3 V	R_{OL}		10		Ω
V_{OUT} Turn−on time (10% to 90%)	I_{LOAD} = 0 mA, V_{IN} = 3 V	T_{ON}		0.5		ms
$\overline{SHDN}$ Logic High Level		V_{IH}	1.3			V
$\overline{SHDN}$ Logic Low Level		V_{IL}			0.4	V
Reverse Leakage into OUT pin	V_{OUT} = 5 V, Shutdown mode, V_{IN} = 3.0 V	I_{ROUT}		15	30	μA
Reverse Leakage from IN pin	V_{OUT} = 5 V, Shutdown mode, V_{IN} = 3.0 V	I_{RIN}			1	μA
Short−circuit Output	V_{OUT} = 0 V	I_{SC}		80		mA
Thermal Shutdown		T_{SD}		160		°C
Thermal Hysteresis		T_{HYST}		20		°C

TYPICAL PERFORMANCE CHARACTERISTICS

(V_{IN} = 3.3 V, V_{FB} = GND (5 V output), C_{IN} = C_{OUT} = C_{FLY} = 1 μF, T_{AMB} = 25°C)
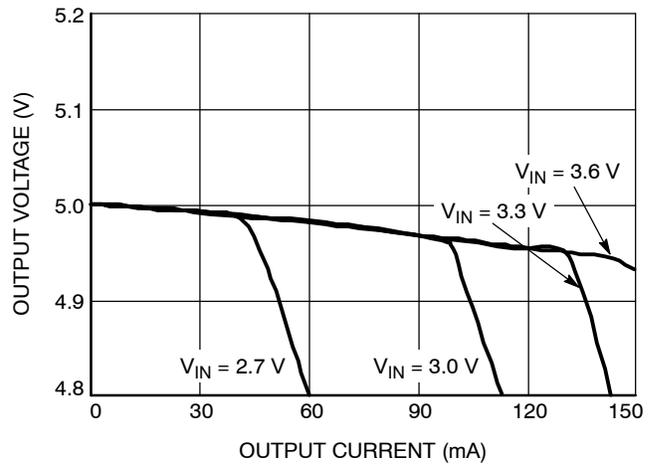
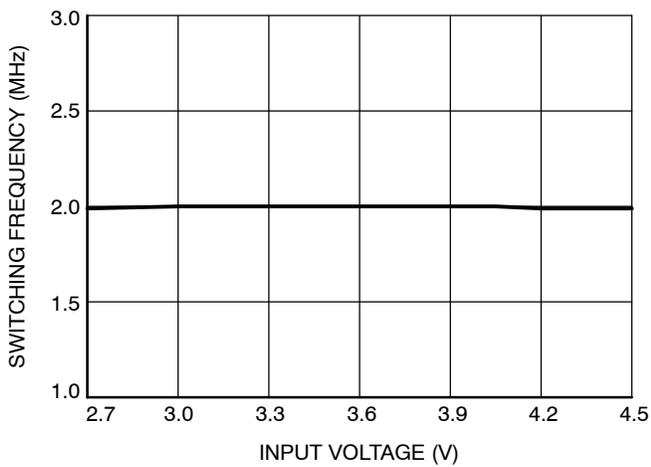**Figure 2. Shutdown Input Threshold vs. Input Voltage**
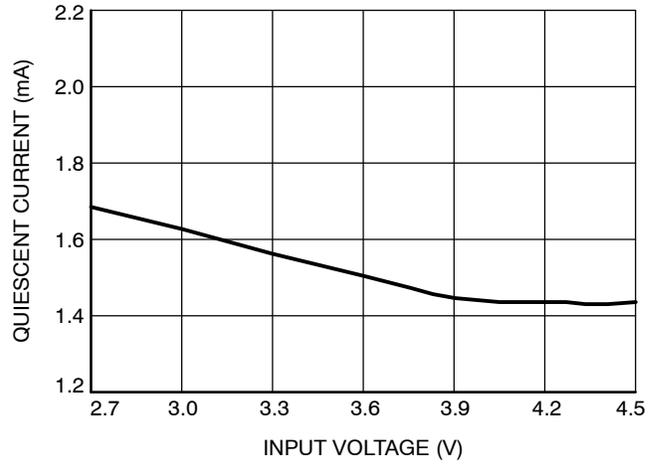
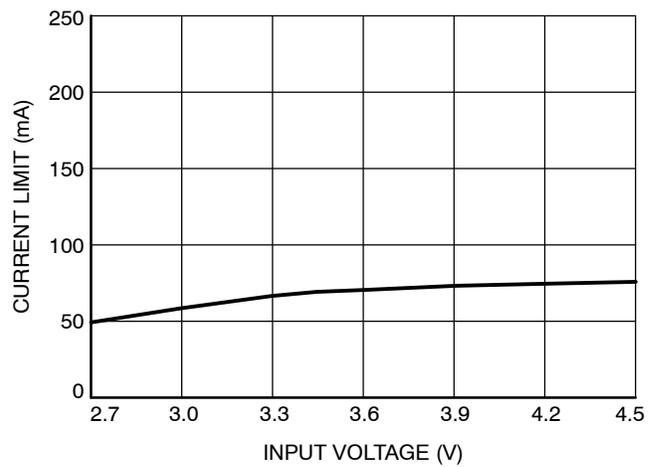**Figure 3. Quiescent Current vs. Input Voltage (No Load)**
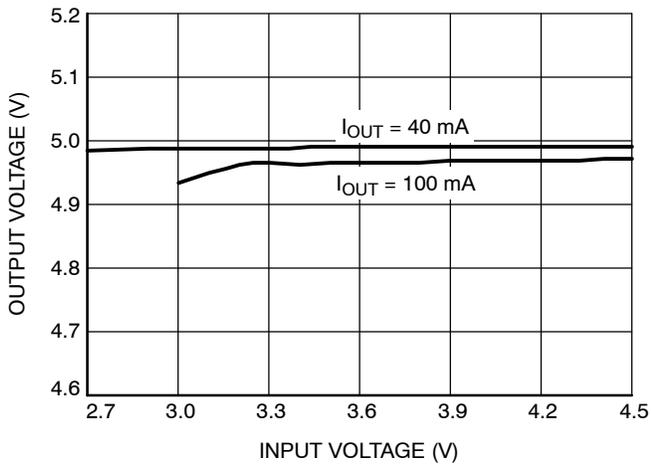
Figure 4. Output Voltage vs. Input Voltage

Figure 5. Output Voltage vs. Output Current

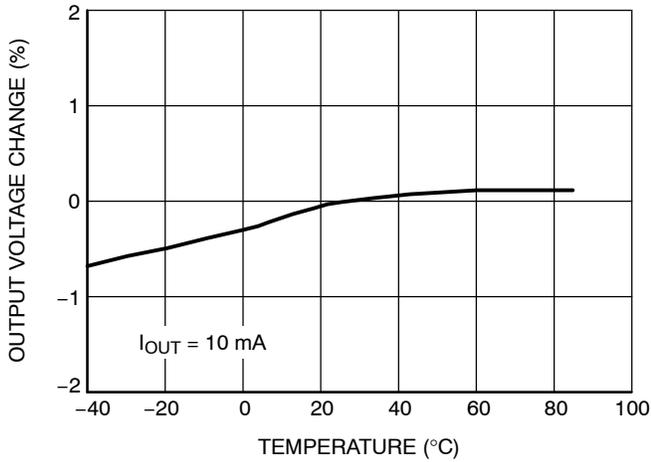**Figure 6. Oscillator Frequency vs. Input Voltage**
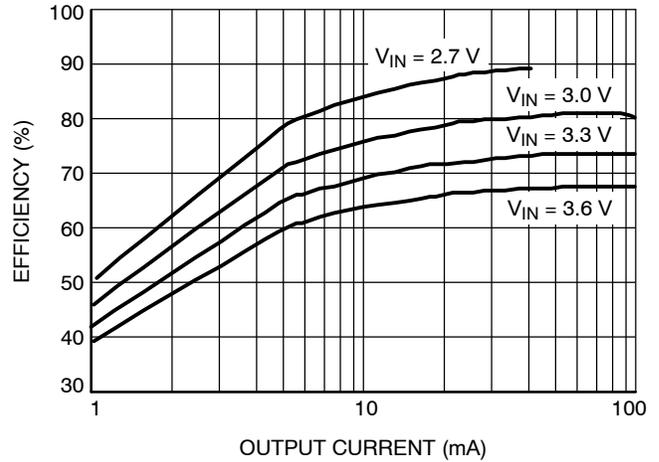
Figure 7. Short Circuit Current vs. Input Voltage

TYPICAL PERFORMANCE CHARACTERISTICS

(V_{IN} = 3.3 V, V_{FB} = GND (5 V output), C_{IN} = C_{OUT} = C_{FLY} = 1 μF, T_{AMB} = 25°C)

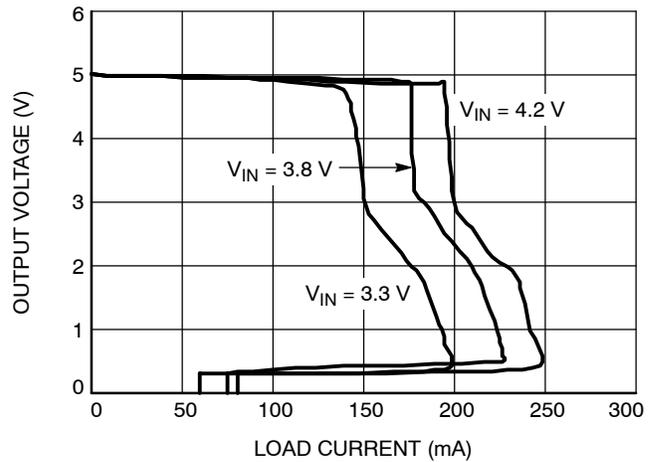**Figure 8. Output Voltage Change vs. Temperature**

Figure 9. Efficiency vs. Output Current
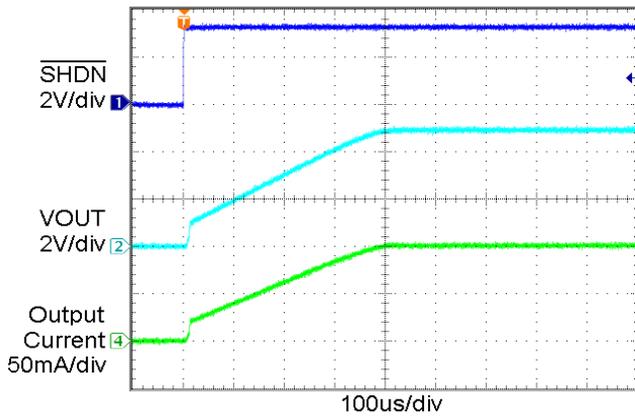
Figure 10. Power Up Waveform (I_{OUT} = 100 mA)
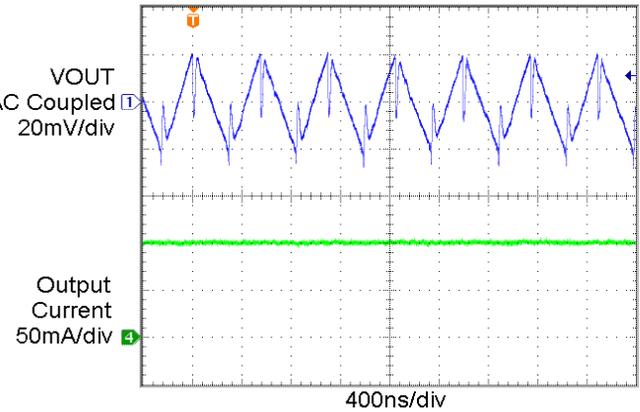
Figure 11. Output Ripple Voltage (I_{OUT} = 100 mA)
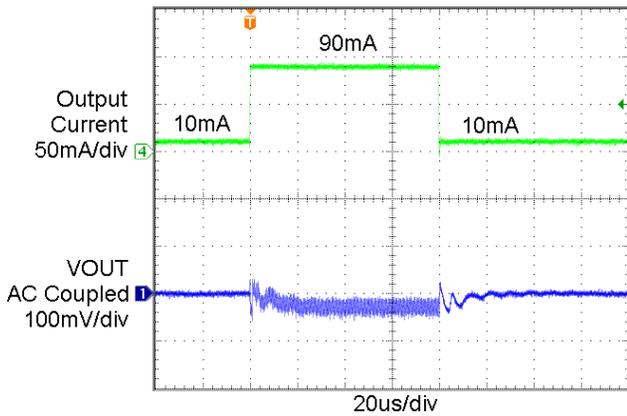
Figure 12. Load Transient Response

Figure 13. Foldback Current Limit

CAT3200HU2

TYPICAL PERFORMANCE CHARACTERISTICS

(V_{IN} = 2.5 V, V_{OUT} = 3.3 V (adjustable output), R1 = 16 kΩ, R2 = 10 kΩ, C_{IN} = C_{OUT} = C_{FLY} = 1 μF, T_{AMB} = 25°C)
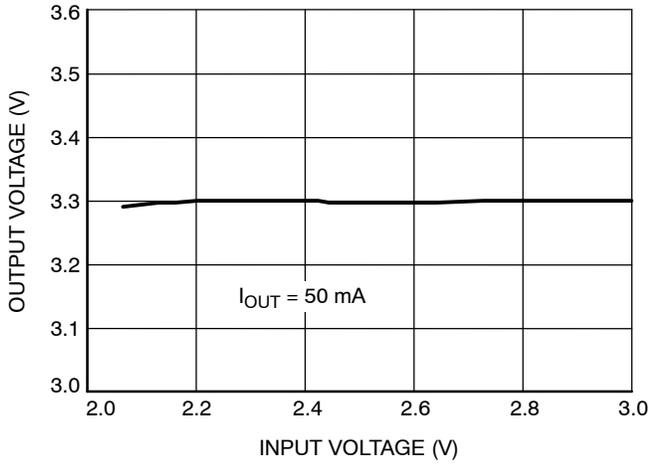
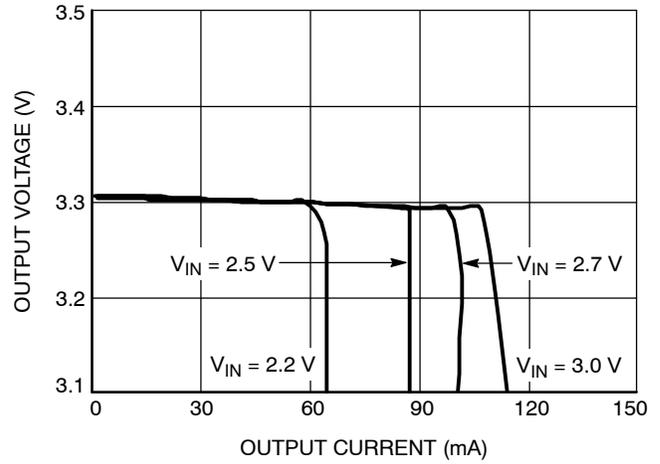**Figure 14. Output Voltage vs. Input Voltage**
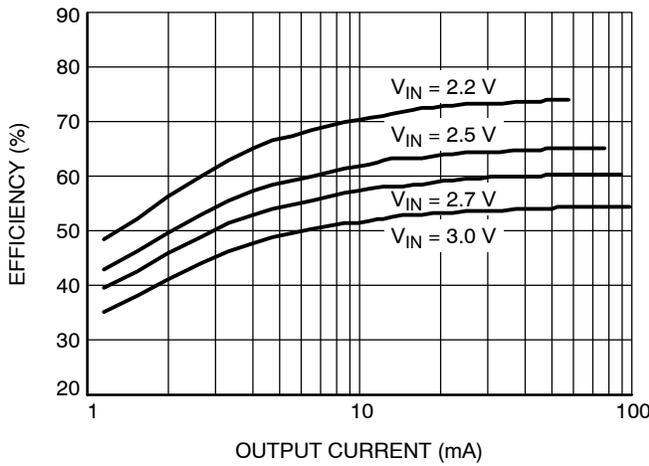
Figure 15. Output Voltage vs. Output Current

Figure 16. Efficiency vs. Output Current

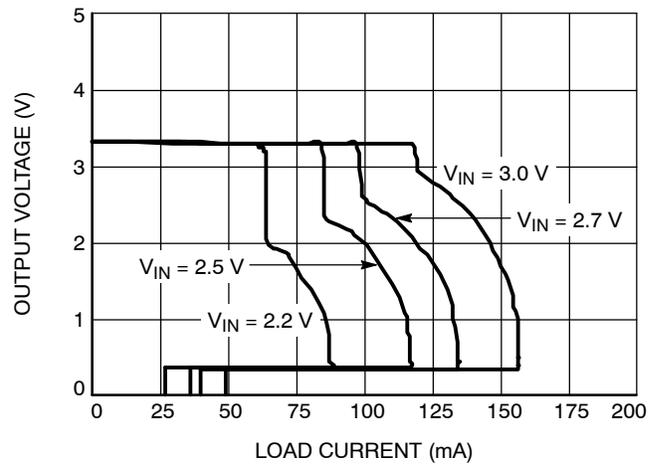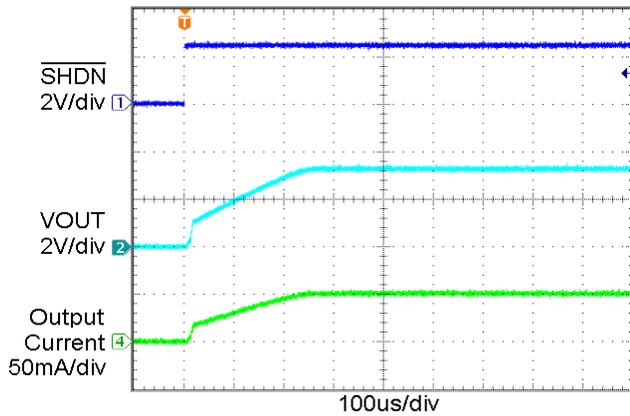**Figure 17. Foldback Current Limit**

Figure 18. Power Up Waveform
(I_{OUT} = 50 mA)

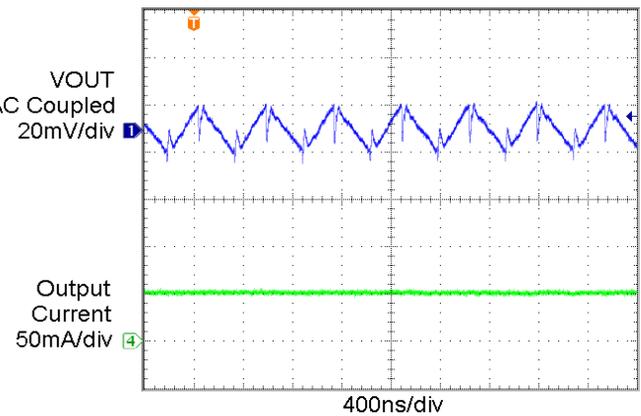**Figure 19. Output Ripple Voltage**
(I_{OUT} = 50 mA)

CAT3200HU2

Pin Functions

VIN is the power supply. During normal operation the device draws a supply current which is almost constant. A very brief interval of non−conduction will occur at the switching frequency. The duration of the non−conduction interval is set by the internal non−overlapping "break−before−make" timing. VIN should be bypassed with a 1 μF to 4.7 μF low ESR (Equivalent Series Resistance) ceramic capacitor.

For filtering, a low ESR ceramic bypass capacitor (1 μF) in close proximity to the IN pin prevents noise from being injected back into the power supply.

$\overline{\text{SHDN}}$ is the logic control input (active low) that places the device into shutdown mode. The internal logic is CMOS and the pin does not use an internal pull−down resistor. The $\overline{\text{SHDN}}$ pin should not be allowed to float.

CPOS, CNEG pins are the positive and negative connections respectively for the charge pump flying capacitor. A low ESR ceramic capacitor (1 μF) should be connected between these pins. During initial power−up it may be possible for the capacitor to experience a voltage reversal and for this reason, avoid using a polarized (tantalum or aluminum) flying capacitor.

VOUT is the regulated output voltage to power the load. During normal operation, the device will deliver a train of current pulses to the pin at a frequency of 2 MHz. Adequate filtering on the pin can typically be achieved through the use of a low ESR ceramic bypass capacitor (1 μF to 4.7 μF) in close proximity to the VOUT pin. The ESR of the output capacitor will directly influence the output ripple voltage.

When the shutdown mode is entered, the output is immediately isolated from the input supply, however, the output will remain connected to the internal feedback resistor network (400 kΩ). The feedback network will result in a reverse current of 10 μA to 20 μA to flow back through the device to ground.

Whenever the device is taken out of shutdown mode, the output voltage will experience a slew rate controlled power−up. Full operating voltage is typically achieved in less than 0.5 ms.

SGND is the ground reference for all voltages on the CAT3200HU2.

FB is the feedback input pin. An output divider should be connected from VOUT to FB to program the output voltage when used in adjustable output mode. When used in 5 V fixed output mode, connect the FB pin directly to GND.

PGND is the power ground.

Device Operation

The CAT3200HU2 uses a switched capacitor charge pump to boost the voltage at IN to a regulated output voltage. Regulation is achieved by sensing the output voltage through an internal resistor divider (FB pin = GND) and modulating the charge pump output current based on the error signal. A 2−phase non−overlapping clock activates the charge pump switches. The flying capacitor is charged from the IN voltage on the first phase of the clock. On the second phase of the clock it is stacked in series with the input voltage and connected to VOUT. The charging and discharging the flying capacitor continues at a free running frequency of typically 2 MHz.

In shutdown mode all circuitry is turned off and the CAT3200HU2 draws only leakage current from the VIN supply. VOUT is disconnected from VIN. The $\overline{\text{SHDN}}$ pin is a CMOS input with a threshold voltage of approximately 0.8 V. The CAT3200HU2 is in shutdown when a logic LOW is applied to the $\overline{\text{SHDN}}$ pin. The $\overline{\text{SHDN}}$ pin is a high impedance CMOS input. $\overline{\text{SHDN}}$ does not have an internal pull−down resistor and should not be allowed to float. It must always be driven with a valid logic level.

Short−Circuit and Thermal Protection

The CAT3200HU2 has built−in short−circuit current limiting and over temperature protection. During overload conditions, output current is limited to approximately 225 mA. At higher temperatures, or if the input voltage is high enough to cause excessive chip self heating, the thermal shutdown circuit shuts down the charge pump as the junction temperature exceeds approximately 160°C. Once the junction temperature drops back to approximately 140°C, the charge pump is enabled. The CAT3200HU2 will cycle in and out of thermal shutdown indefinitely without latch−up or damage until a short−circuit on VOUT is removed.

Programming the CAT3200HU2 Output Voltage (FB Pin)

The CAT3200HU2 version has an internal resistive divider to program the output voltage. The programmable CAT3200HU2 may be set to an arbitrary voltage via an external resistive divider. Since it employs a voltage doubling charge pump, it is not possible to achieve output voltages greater than twice the available input voltage. Figure 20 shows the required voltage divider connection. The voltage divider ratio is given by the formula:

$$\frac{R1}{R2} = \frac{V_{OUT}}{1.27\ V} - 1$$

Typical values for total voltage divider resistance can range from several kΩ up to 1 MΩ.
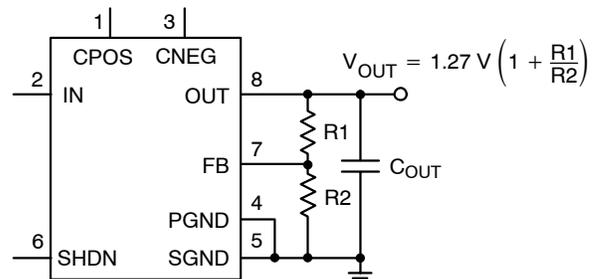
Figure 20. Programming the Adjustable Output

$$V_{OUT} = 1.27\ V \left(1 + \frac{R1}{R2}\right)$$

CAT3200HU2

Application Information

Ceramic Capacitors

Ceramic capacitors of different dielectric materials lose their capacitance with higher temperature and voltage at different rates. For example, a capacitor made of X5R or X7R material will retain most of its capacitance from −40°C to 85°C whereas a Z5U or Y5V style capacitor will lose considerable capacitance over that range.

Z5U and Y5V capacitors may also have voltage coefficient causing them to lose 60% or more of their capacitance when the rated voltage is applied. When comparing different capacitors it is often useful to consider the amount of achievable capacitance for a given case size rather than discussing the specified capacitance value. For example, over rated voltage and temperature conditions, a 1 μF, 10 V, Y5V ceramic capacitor in an 0603 case may not provide any more capacitance than a 0.22 μF, 10 V, X7R available in the same 0603 case. For many CAT3200HU2 applications these capacitors can be considered roughly equivalent.

Output Ripple

The output ripple voltage is related to the output capacitor size C_{OUT} and ESR (equivalent series resistance) and can be calculated using the formula below:

$$V_R = I_{LOAD} / (2 \cdot F_{OSC} \cdot C_{OUT}) + 2 \cdot ESR_{COUT} \cdot I_{LOAD}$$

where F_{OSC} is the switching frequency.

Efficiency

The efficiency is basically set by the ratio between the input voltage V_{IN} and the output voltage V_{OUT}, and can be calculated using the formula below:

$$\text{Efficiency [\%]} = 100 \cdot P_{OUT} / P_{IN}$$
$$= 100 \cdot V_{OUT} \cdot I_{LOAD} / (V_{IN} \cdot I_{IN})$$

where F_{OSC} is the switching frequency, and

$$I_{IN} = I_{GND} + 2 \cdot I_{LOAD}$$

If we neglect the Ground current (I_{GND}), then the efficiency is basically equal to:

$$\text{Efficiency [\%]} \cong 100 \cdot V_{OUT} / (2 \cdot V_{IN})$$

CAT3200HU2

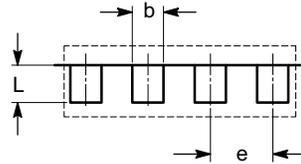## PACKAGE DIMENSIONS

UDFN8, 2x2
CASE 517AW−01
ISSUE O

TOP VIEW

SIDE VIEW

BOTTOM VIEW

DETAIL A

PIN #1 INDEX AREA

DETAIL A

PIN #1 IDENTIFICATION
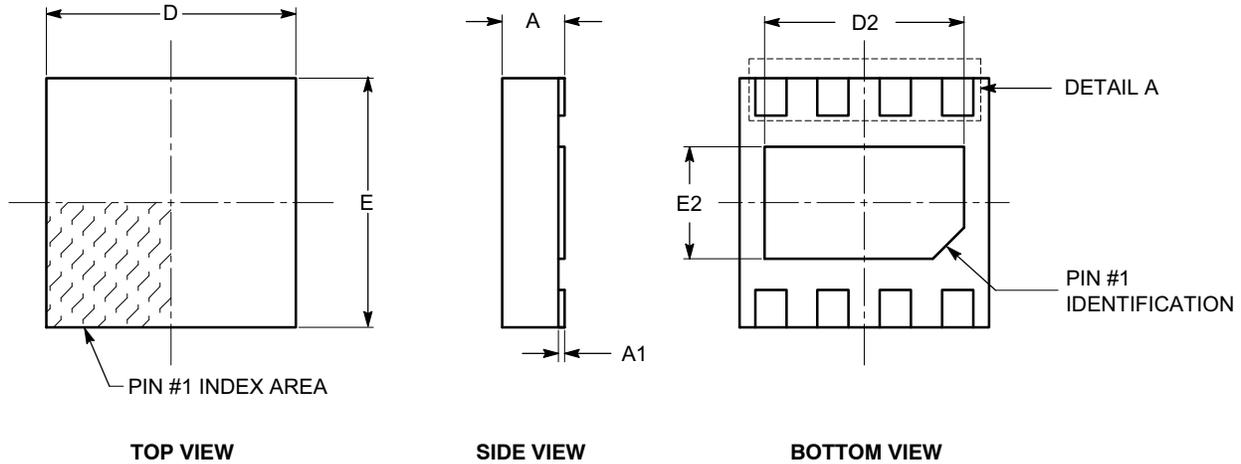
SYMBOL	MIN	NOM	MAX
A	0.45	0.50	0.55
A1	0.00	0.02	0.05
b	0.18	0.25	0.30
D	1.90	2.00	2.10
D2	1.50	1.60	1.70
E	1.90	2.00	2.10
E2	0.80	0.90	1.00
e	0.50 BSC		
L	0.20	0.30	0.45

Notes:

(1) All dimensions are in millimeters.
(2) Complies with JEDEC MO-229.